Technological advances within the field of micro multisensors: A Nordic perspective

"IAQ Sensors – a quick Nordic overview", Bertil Hök, Hök Instrument AB (<u>www.hokinstrument.se</u>)

"MASCOT: Micro-acoustic sensors for CO2 tracking", Per G. Gløersen, SensoNor AS (<u>www.sensonor.com</u>)

"Future Nordic Sensors" Niels Peter Østbø, SINTEF (<u>www.sintef.no</u>)



IAQ (indoor air quality) sensors - a quick Nordic overview

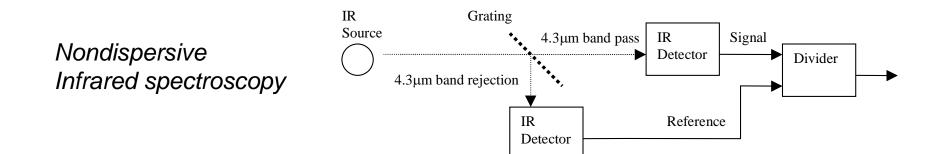
Bertil Hök HÖK INSTRUMENT AB

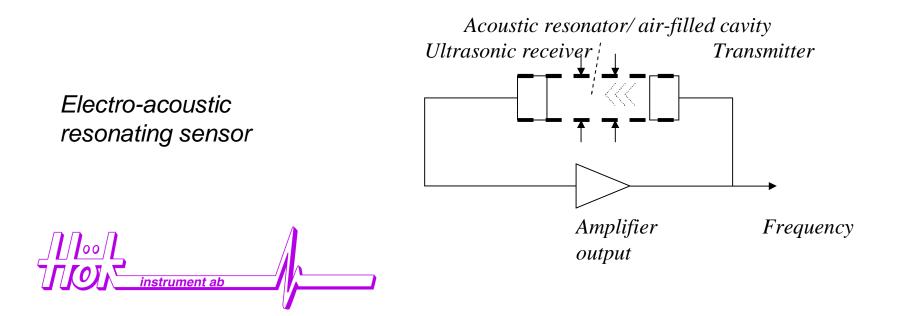
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IAQ monitoring & control variables

- Temperature
- Relative humidity
- Carbon dioxide concentration
- Particles, microorganisms (pollen...)
- Volatile Organic Compounds (VOC)
- Other gases (NO_x, ozone, ...)

CO₂ sensor principles





SenseAir infrared IAQ sensors



Housing for industrial environments

 $\rm CO_2$ sensor for embedded solutions

/ 00 instrument ab

Electro-acoustic IAQ sensor



instrument ab

Nordic IAQ sensor suppliers

- kT Sensors, Norway, ktsensor.no
- Optosense, Norway, optosense.com
- Vaisala, Finland, vaisala.fi
- SenseAir, Sweden, senseair.se
- Hök Instrument AB, Sweden, hokinstrument.se



MASCOT: Micro-Acoustic Sensors for CO_2 Tracking

Per Gerhard Gløersen, SensoNor AS Bertil Hök, Hök Instrument AB Niels Peter Østbø, SINTEF





The MASCOT project was cofinanced by the IST programme of the European Commission under grant number IST-2001-32411

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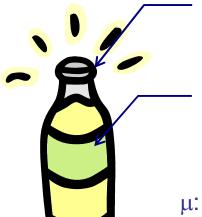
Device modelling basics

Relationship between velocity of sound c and molecular mass M of a gas:

$$c = \sqrt{\frac{RT\gamma}{M}}$$

R: universal gas constant (=8.314 J/mol K),
T: absolute temperature (K)
γ: Ratio of specific heat at constant pressure and volume

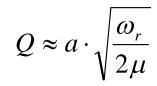
Resonant frequency and Q of a Helmholtz resonator:



Neck effective length *l* and area A (radius a)

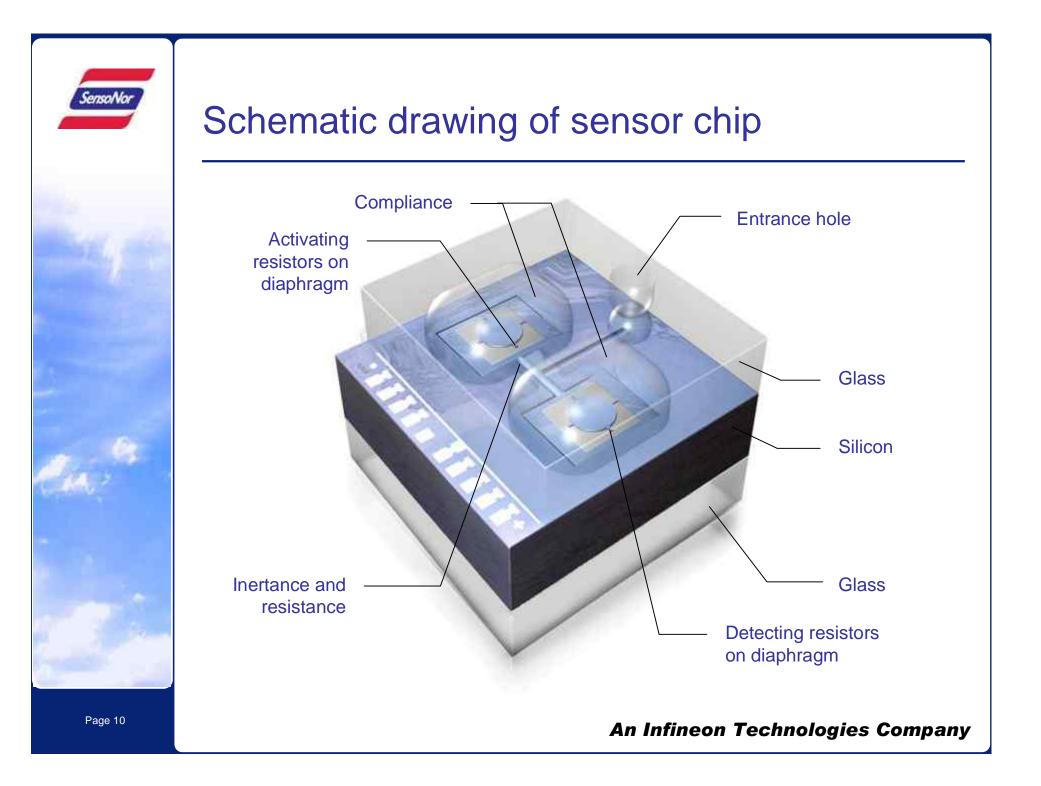
$$f_r = \frac{c}{2\pi} \sqrt{\frac{A}{\ell \cdot V}}$$

Compliant gas volume V



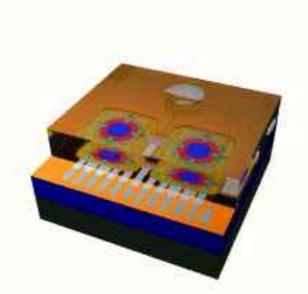
 $\boldsymbol{\mu}\!\!:$ kinematic viscosity of gas

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MASCOT in operation



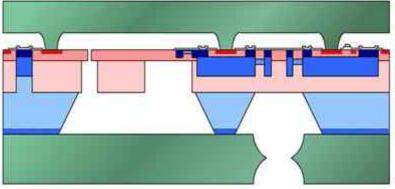
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Features of MEMS process

- Buried piezoresistors for precise and stable transduction of stress signals
- Sealed cavities for reference pressures
- Microchannels for gas / liquid flow
- Controlled 3D features for micromachined MEMS elements such as masses, beams, channels, springs and diaphragms
- Materials compatible with a large range of media / environments
- Wafer-level package provides stable enclosure and environmental protection for the sensor chip
- SensoNor's process platform is QS 9000 certified for automotive high-volume sensor production.

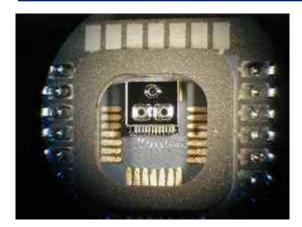


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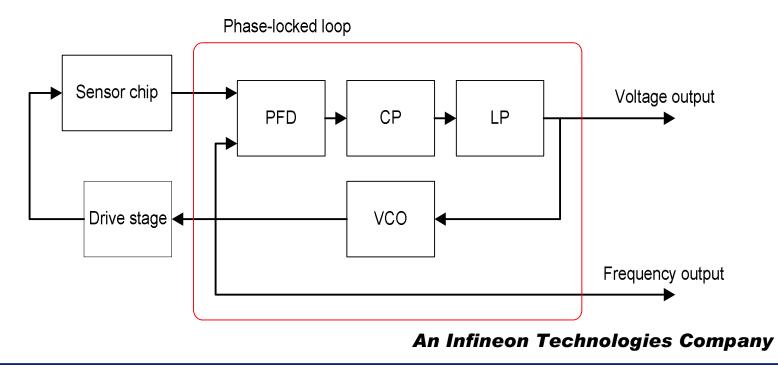


Packaged prototype and system solution

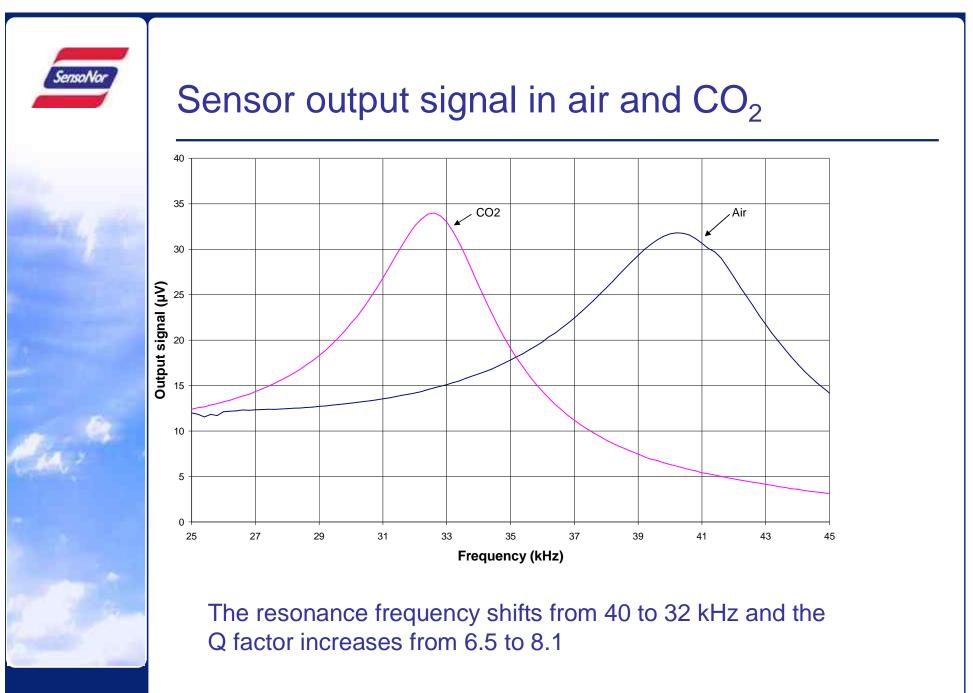


A large variety of sensors were produced with a range of characteristic dimensions

Sensor chip area: 3 x 3 mm. Packaged in a standard ceramic package



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Sensor characteristics

	f _r	Q
Typical value	40250 Hz	6.60
CO ₂	-11 Hz/1000ppm	+0.009/1000ppm
RH	+4 Hz/%RH	-0.001/%RH
Тетр	63 Hz/°C	-0.015/°C
Pressure	0	+0.04/kPa
Resolution	±2 Hz (±200 ppm CO ₂ or ±0.5% RH)	±0.01

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Conclusions

- A new class of MEMS-implemented CO₂ sensors has been demonstrated:
 - Simple and uncritical geometry
 - Strong potential for mass-production at low cost
- A PLL-based electronic interface ASIC has been implemented in a separate study (A. E. Edvardsen et al., Norchip 2004)
- The MASCOT project results on modelling, implementation and characterisation has established a platform for further development and performance optimisation
- The application area may be extended to other gas species
- Advantages of the MASCOT concept:
 - Performance / cost
 - Elimination of aging effects (improved lifetime and reliability)
- Industrial alliance partners are sought for the next step in the innovation process



Future Nordic Sensors Outline: A few examples from SINTEF...

ICT

Microsystems and Nanotechnology

SINTEF + NBI merger January 2006

NBI=Norwegian Building Research Institute

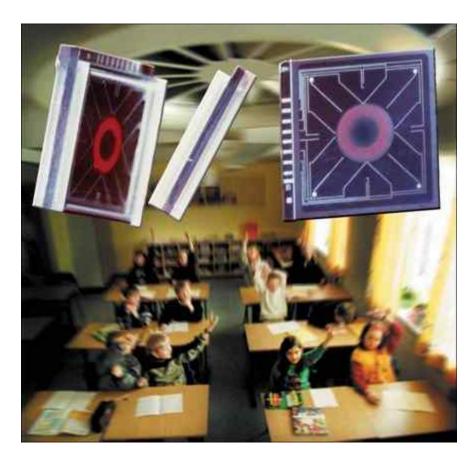
MASCOT... (Presented by Per)
 R&D on Other new technologies

MEMS possibilities

IP Proposal "Multi-CEPOC"



PhotoAcoustic Gas Sensor

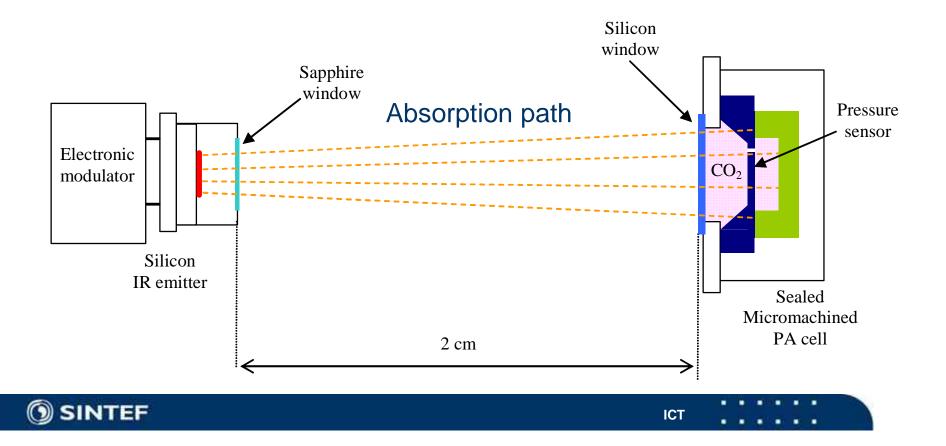


- MEMS Pressure sensor
- IR-source chip
- Reference Gas
- Goal: SINGLE Chip
- Wafer-level packaging



PhotoAcoustic Gas Sensor

- A photo acoustic signal is generated in the micromachined PA cell
- The signal is measured by the pressure sensor (microphone)
- The pressure signal is reduced when target gas is present in the absorption path, due to the loss of IR transmission



Advanced NDIR- SIMRAD Gas sensors

- "Silicon chip inside"
- IR-source

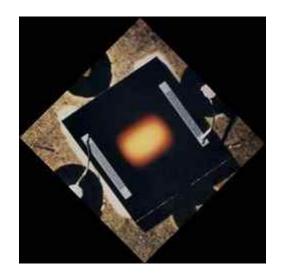
SIMRAD Optronics
 Offshore Gas-sensors
 20 years life-time...



Advanced NDIR- (IR-source) II

- "Silicon chip inside"
- IR-source

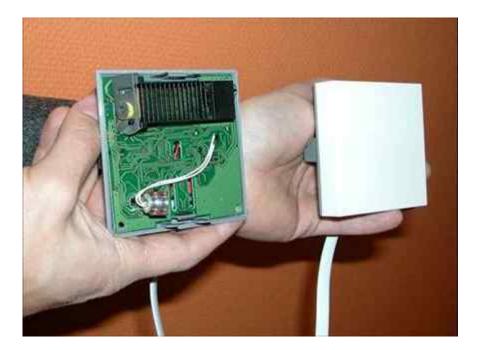
- SIMRAD Optronics
 Offshore Gas-sensors
 20 year life-time...
- Now "State-of-the-art" and soon low-cost...





Diffractive Optical Elements

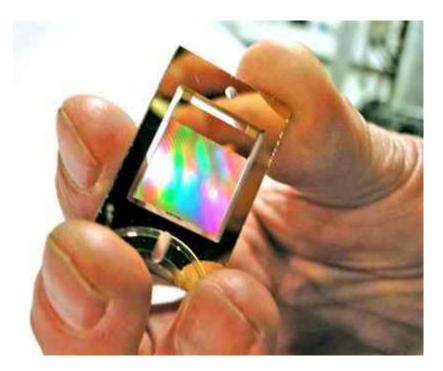
- "DOE-inside"
- Polymer replication possible
 - CD-technology...
- Optical spectrometer/ dedicated sensor for CO₂
- OptoSense AS
 - Demo
 - Folded polymer light/absorption path





Diffractive Optical Elements (DOE)

- "DOE-inside"
- Polymer replication possible
 - CD-technology...
- OptoSense AS
 - Demo
 - Folded polymer light/absorption path
 - Polymer chip...
 - Shown: gold-plated Si-chip





IP Proposal Multi-CEPOC

Multi-CEPOC

Call FP6-2006-IST-6, instrument IP

- 29 partners
 - 15 countries, 10 SMEs
- 16 MEUR
- Networked Embedded Systems
- Ambient intelligence for:
 - Ambient comfort
 - Healthy, productive workers and school children
 - Energy savings
 - Cost savings...



Proputational IP Multisensors for Controlling Indoor Environment Parameters by Optimal HVAC Control — A case application project for a versatile embedded sensor system

Propusal actives Multi-CEPOC

Call identifier FPis-2005-05T-5 Type of instrument Integrated Project Date of information 2005-09-21 (final version, post submission: v8)

List of porticipants:

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Coordination name: Niels Prior OSTEPO Coordination enail: hpoRhintlef.no Coordination for: -47 22,007,350



